

## Low-Power Low-Jitter MEMS Oscillators

#### **Features**

- · Any Frequency Between:
  - 2.3 MHz to 170 MHz (2.5V and 3.3V)
  - 2.3 MHz to 125 MHz (1.8V)
- Exceptional Total Stability Over Temperature ±20 ppm, ±25 ppm, ±50 ppm
- · Low Phase Jitter (1 ps Typical)
- Operating Voltage 1.8V/2.5V to 3.3V
- · Standby Mode for Battery Life Saving
- Fast Startup Time (2.5 ms Typical)
- Extended Temperature Range: –40°C to +125°C
- Low Operation Current (6.5 mA Typical)
- · Ultra-Small Footprints:
  - 2.0 mm x 1.6 mm LGA Package
  - 2.5 mm x 2.0 mm LGA Package
  - 7.0 mm x 5.0 mm DFN Package
- High Reliability: 20x Better MTF than Quartz Oscillators
- · MIL-STD 883 Shock and Vibration Resistant
- · Lead-Free and RoHS-Compliant

#### **Applications**

- · USB, SATA, SAS Reference Clock
- 100M/1G/10G Ethernet Clock
- · IP Cam, DVR, OTT-Box
- Storage/SSD
- IoT Terminal/Gateway

#### **Benefits**

- Pin for Pin "Drop-In" Replacement for Industry Standard Oscillators
- Semiconductor-Level Reliability, Significantly Higher than Quartz
- · Short Production Lead Time
- · Longer Battery Life/Reduced Power Consumption
- · Compact Plastic Package
- · Cost Effective

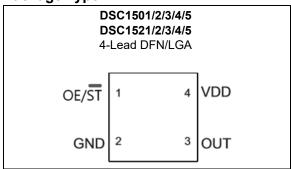
#### **General Description**

The DSC1501/2/3/4/5 and DSC1521/2/3/4/5 are industry-leading MEMS oscillators that offer excellent jitter and stability performance at very low power over a wide range of supply voltage (1.71V to 3.63V) and temperature ( $-40^{\circ}$ C to +125°C). The devices operate from 2.3 MHz to 170 MHz with 2.5V and 3.3V supply voltage and from 2.3 MHz to 125 MHz with 1.8V supply voltage.

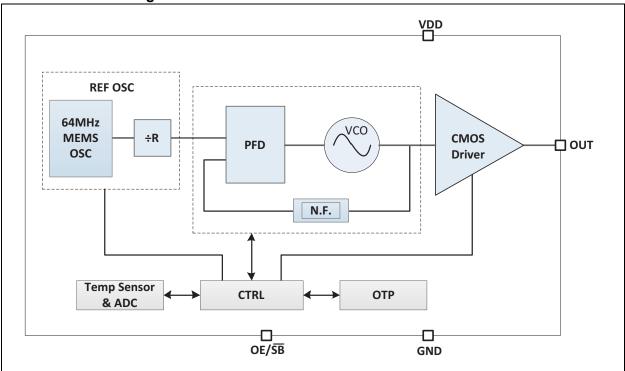
The devices incorporate an all-silicon resonator that is extremely robust. A MEMS-based design allows for a higher level of reliability, making the DSC150x/DSC152x ideal for rugged, industrial, and portable applications where stress, shock, and vibrations can damage quartz crystal-based systems. The devices are also an excellent choice as clock reference for small, battery-operated devices, such as wearables and Internet-of-Things (IoT) devices.

Available in industry standard packages, the DSC150x/DSC152x can be a drop-in replacement to standard crystal oscillators.

#### Package Type



## **Functional Block Diagram**



### 1.0 ELECTRICAL CHARACTERISTICS

## **Absolute Maximum Ratings** † ††

Supply Voltage (V	<sup>'</sup> cc)	–0.3V to +4.0V
	ge	
	НВМ)	
,	лм) <sup>′</sup>	
•	CDM)	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

**†† Notice:** The data sheet limits are not guaranteed if the device is operated beyond the recommended operating conditions.

#### **ELECTRICAL CHARACTERISTICS**

**Electrical Characteristics:**  $V_{DD}$  = 1.8V +10%/–5%,  $V_{DD}$  = 2.5V ±10%,  $V_{DD}$  = 3.3V ±10%;  $T_A$  = -40°C to +125°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	Conditions		
Ol Valta aa	.,	2.25		3.63	V	Note 1, DS0	C1501/2/3, DSC1521/2/3		
Supply Voltage	$V_{DD}$	1.71		1.98	V	Note 1, DSC1504/5, DSC1524/5			
Power Supply Ramp	t <sub>PU</sub>	0.1	_	100	ms	Note 2	Note 2		
Supply Current	1	_	6.5	7.5	mA	$f_0$ = 20 MHz, $V_{DD}$ = 3.3V, no load, ou enabled			
Зирріу Сипені	I <sub>DD</sub>	_	6.5	7.8	ША	f <sub>VCO</sub> = 141 load, output	249 MHz, V <sub>DD</sub> = 3.3V, no disabled		
Standby Current	lanna	_	1	_	μA	$V_{DD} = 1.8 V_{A}$	2.5V		
Standby Current	I <sub>STDBY</sub> _	_	1.8	_	μΛ	$V_{DD} = 3.3V$			
Input Logic Levels	V <sub>IH</sub>	0.7 x V <sub>DD</sub>	_	_	V	Input logic I	ligh, Note 3		
Input Logio Levels	$V_{IL}$	_	_	0.3 x V <sub>DD</sub>	v	Input logic Low, Note 3			
	V <sub>OH</sub>		_	_	V	V <sub>DD</sub> = 3.3V	I <sub>OH</sub> = –16 mA, Std. drive		
		0.8 x V <sub>DD</sub>	_	_			$I_{OH} = -12$ mA, Medium drive		
			_	_			I <sub>OH</sub> = –6 mA, Low drive		
Output Logic Levels			_	_		$V_{DD} = 2.5V$ $V_{DD} = 1.8V$	I <sub>OH</sub> = –10 mA, Std. drive		
Output Logic Levels			_	_			I <sub>OH</sub> = –6 mA, Medium drive		
			_	_			I <sub>OH</sub> = –3 mA, Low drive		
			_	_			I <sub>OH</sub> = –4 mA, Standard drive		
			_	_			I <sub>OH</sub> = –2 mA, Low drive		
			_				I <sub>OL</sub> = 16 mA, Standard drive		
		_				$V_{DD} = 3.3V$	I <sub>OL</sub> = 12 mA, Medium drive		
		_					I <sub>OL</sub> = 6 mA, Low drive		
Output Logic Levels	V <sub>OL</sub>			0.2 x V <sub>DD</sub>	V		I <sub>OL</sub> = 10 mA, Standard drive		
Output Logic Levels	V OL	_		0.2 A VDD	· •	$V_{DD} = 2.5V$	I <sub>OL</sub> = 6 mA, Medium drive		
		_					I <sub>OL</sub> = 3 mA, Low drive		
		_				V <sub>DD</sub> = 1.8V	I <sub>OL</sub> = 4 mA, Standard drive		
		_	_			v <sub>DD</sub> - 1.6V	I <sub>OL</sub> = 2 mA, Low drive		
Output Duty Cycle	_	47	_	53	%				

## **ELECTRICAL CHARACTERISTICS (CONTINUED)**

**Electrical Characteristics:**  $V_{DD}$  = 1.8V +10%/-5%,  $V_{DD}$  = 2.5V ±10%,  $V_{DD}$  = 3.3V ±10%;  $T_A$  = -40°C to +125°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
		2.3	_	170		Standard drive	V <sub>DD</sub> = 3.3V	
_		2.3	_	125		Medium drive	and V <sub>DD</sub> = 2.5V	
Frequency	f <sub>0</sub>	2.3	_	50	MHz	Low drive		
		2.3	_	125		Standard drive	V <sub>DD</sub> = 1.8V	
		2.3	_	60		Low drive		
		_	±20					
Frequency Stability	Δf	_	±25	_	ppm	All temperat	ture ranges	
		_	±50	_				
Aging	۸f	_	±5	_	2000	First year @	) 25°C	
Aging	Δf	_	±1	_	ppm	Per year aft	er first year	
Startup Time	t <sub>SU</sub>	_	2.5	_	ms	From 90% \ toggling	/ <sub>DD</sub> until the output starts	
Output Disable Time	t <sub>ODs</sub>	_	15	_	ns	From OE toggle to output OFF		
Outrout Frankla Times	t <sub>ENOE</sub>	_	_	1	μs	Pin 1 configured as OE		
Output Enable Time	t <sub>ENST</sub>	_	_	2	ms	Pin 1 configured as Standby		
Enable Pull-up Resistor	_	70	_	_	kΩ	Pull-up resistor at pin 1		
		_	1.4/1.3	_		V <sub>DD</sub> = 1.8V	DSC1505, Std drive 20%-80%, C <sub>L</sub> = 10 pF	
		_	1.1/1.0	_		V <sub>DD</sub> = 2.5V		
		_	1.2/1.0	_		V <sub>DD</sub> = 3.3V	20%-80%, C <sub>L</sub> = 10 pF	
Output Transition Time	t <sub>R</sub> /t <sub>F</sub>	_	3.0/2.4	_	ns	V <sub>DD</sub> = 1.8V	DSC1504, Low drive 20%-80%, C <sub>L</sub> = 10 pF	
		_	1.9/1.7	_		V <sub>DD</sub> = 2.5V	DSC1501, Med drive	
		_	1.4/1.1	_		V <sub>DD</sub> = 3.3V	20%-80%, C <sub>L</sub> = 10 pF	
		_	4.5/4.1	_		V <sub>DD</sub> = 2.5V	DSC1503, Low drive	
		_	3.4/2.9	_		V <sub>DD</sub> = 3.3V	20%-80%, C <sub>L</sub> = 10 pF	
		_	40	_		V <sub>DD</sub> = 1.8V		
Cycle-to-Cycle Jitter (Peak)	$J_{CC}$	_	18	_	ps	V <sub>DD</sub> = 2.5V	f <sub>OUT</sub> = 25 MHz	
(reak)		_	15			V <sub>DD</sub> = 3.3V		
		_	6	_		V <sub>DD</sub> = 1.8V		
Period Jitter, RMS	J <sub>PER</sub>	_	2.5	_	ps	V <sub>DD</sub> = 2.5V	f <sub>OUT</sub> = 25 MHz	
	' -''	_	2.5	_		V <sub>DD</sub> = 3.3V		
		_	45	_		V <sub>DD</sub> = 1.8V		
Period Jitter	$J_{PP}$	_	20	_	ps	V <sub>DD</sub> = 2.5V	f <sub>OUT</sub> = 25 MHz	
(Peak-to-Peak)		_	18	_		V <sub>DD</sub> = 3.3V		
Integrated Phase Noise	J <sub>PH</sub>	_	1	_	ps <sub>RMS</sub>	f <sub>OUT</sub> = 100 MHz	12 kHz to 20 MHz, V <sub>DD</sub> = 3.3V	

Note 1:  $V_{DD}$  pin should be filtered with a 0.1  $\mu F$  capacitor.

**<sup>2:</sup>** Time to reach 90% of target  $V_{DD}$ . Power ramp must be monotonic.

<sup>3:</sup> Input waveform must be monotonic with rise/fall time < 10 ms.

## **TEMPERATURE SPECIFICATIONS**

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Operating Ambient Temperature Range	T <sub>A</sub>	-40	_	+125	°C	_
Junction Operating Temperature	TJ	_	_	+125	°C	Note 1
Storage Temperature Range	T <sub>S</sub>	<b>-55</b>	_	+150	°C	_
Lead Temperature	_	_	+260		°C	Soldering, 20 sec.

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, Ψ<sub>JA</sub>). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

## 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
4	OE	Output Enabled: H = Output buffer Enabled, L = Disabled (High impedance): External pull-up recommended for normal operation.
1	STB	Standby: H = Device is active, L = Device is in Standby (Both output buffer and PLL disabled): External pull-up recommended for normal operation.
2	GND	Ground
3	OUT	Oscillator clock output
4	VDD	Power Supply: 1.71V to 3.63V

## 3.0 TYPICAL PHASE NOISE PLOT

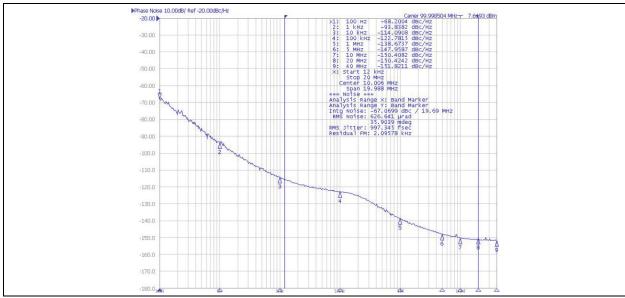


FIGURE 3-1: Typical Phase Noise @ 25°C, 100 MHz, 3.3V.

## 4.0 OUTPUT WAVEFORM

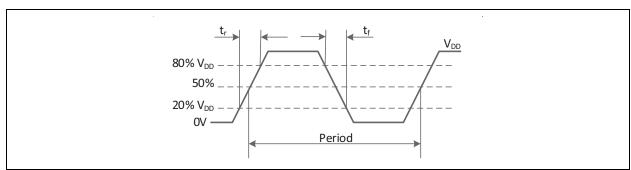


FIGURE 4-1: Output Waveform.

## 5.0 TEST CIRCUIT

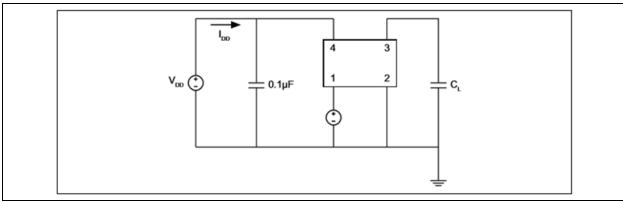


FIGURE 5-1: Test Circuit.

### 6.0 TIMING DIAGRAMS

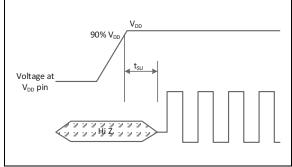


FIGURE 6-1: Start-Up Time.

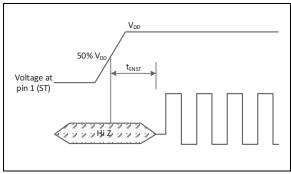


FIGURE 6-2: Enable Time with Pin 1 Configured as Standby (STB).

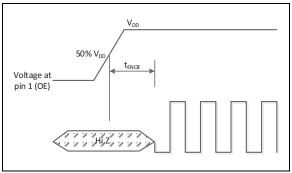


FIGURE 6-3: Enable Time with Pin 1 Configured as OE.

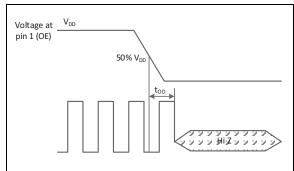


FIGURE 6-4: Disable Time with Pin 1 Configured as OE.

As shown, the output Enable/Disable in OE mode (pin 1 configured as OE) happens at the clock falling edge while in Standby mode (pin 1 configured as STB) it happens asynchronously.

## 7.0 SOLDER REFLOW PROFILE

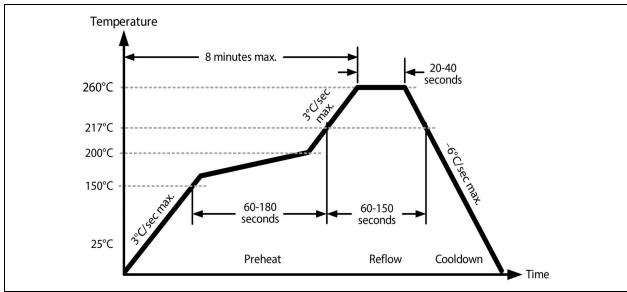


FIGURE 7-1: Solder Reflow Profile.

TABLE 7-1: SOLDER REFLOW

MSL 1 @ 250°C Refer to JSTD-020C					
Ramp-Up Rate (200°C to Peak Temp.)	3°C/sec. max.				
Preheat Time 150°C to 200°C	60 to 180 sec.				
Time Maintained above 217°C	60 to 150 sec.				
Peak Temperature	255°C to 260°C				
Time within 5°C of Actual Peak	20 to 40 sec.				
Ramp-Down Rate	−6°C/sec. max.				
Time 25°C to Peak Temperature	8 minutes max.				

### 8.0 FUNCTIONAL DESCRIPTION

The DSC150x/DSC152x are MEMS-based CMOS oscillators that combine excellent jitter and stability performance at a very low power over a wide range of supply voltage and temperature. The device operates from 2.3 MHz to 170 MHz with 2.5V and 3.3V supply voltage and from 2.3 MHz to 125 MHz with 1.8V supply voltage over -40°C to +125°C temperature range. It has four pins and comes in different industry-standard package sizes.

The standard DSC150x/DSC152x comes with standard output drive strength with optional low and high drive strengths (see Table 8-1). Low output drive strength offers slower edge rates for lower EMI interference.

TABLE 8-1: OUTPUT DRIVE STRENGTH

Device	CMOS Output Strength				
DSC1501/21	LVCMOS Medium drive (2.5V/3.3V)				
DSC1502/22	LVCMOS Standard drive (2.5V/3.3V)				
DSC1503/23	LVCMOS Low drive (2.5V/3.3V)				
DSC1504/24	LVCMOS Low drive (1.8V)				
DSC1505/25	LVCMOS Standard drive (1.8V)				

Pin 1 can be programmed to implement Enable function (OE) or Standby function (STB).

TABLE 8-2: ENABLE AND STANDBY FUNCTION

Control Pin (Pin 1) Definition							
P/N	Function	Pin 1 High	Pin 1 Low				
DSC150x	Standby	Active	Standby				
DSC152x	Enable/Disable	Enable	Disable				

Users can build the part with their desired output drive strength and pin 1 control pin options by using the ClockWorks Configurator online tool.

## 9.0 RECOMMENDED BOARD LAYOUT

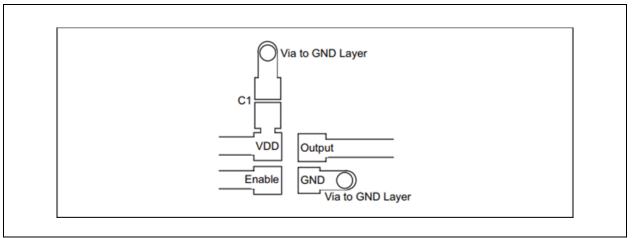
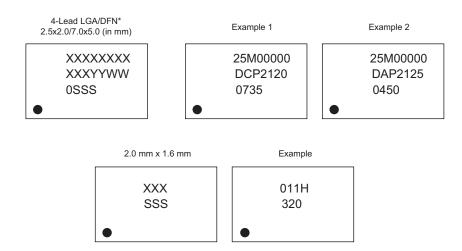
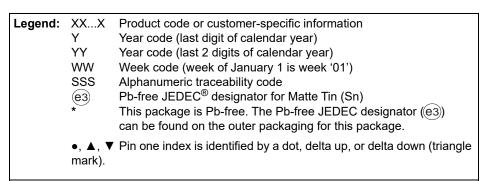


FIGURE 9-1: Recommended Board Layout.

### 10.0 PACKAGING INFORMATION

## 10.1 Package Marking Information

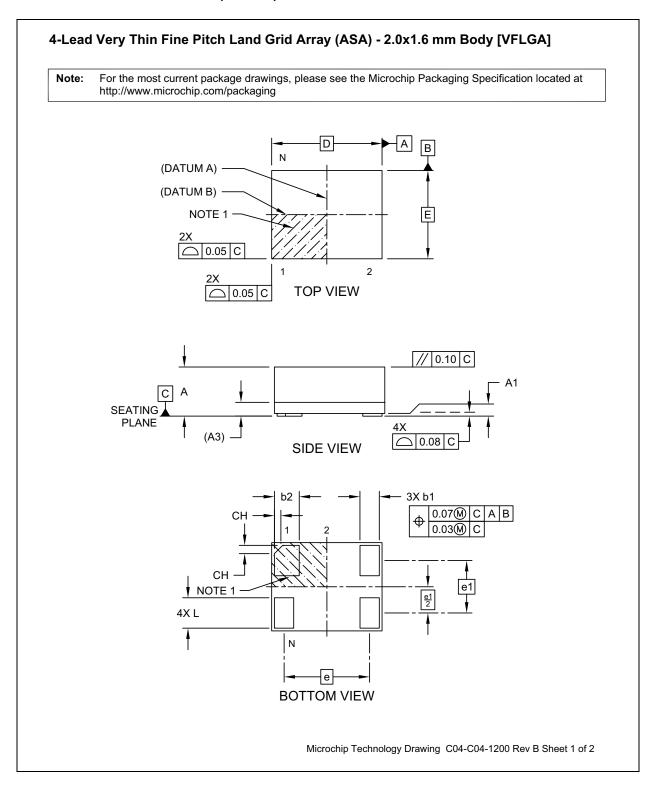




**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

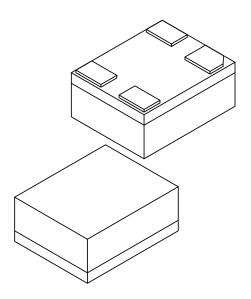
Underbar (\_) and/or Overbar (¯) symbol may not be to scale.

# 4-Lead Very Thin Fine Pitch Land Grid Array (ASA) 2.0 mm x 1.6 mm Package Outline and Recommended Land Pattern (VFLGA)



## 4-Lead Very Thin Fine Pitch Land Grid Array (ASA) - 2.0x1.6 mm Body [VFLGA]

For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension	MIN	NOM	MAX		
Number of Terminals	N	6			
Terminal Pitch	е		1.55 BSC		
Terminal Pitch	e1		0.95 BSC		
Overall Height	Α	0.79	0.84	0.89	
Standoff	A1	0.00	0.02	0.05	
Substrate Thickness (with Terminals)	A3	0.20 REF			
Overall Length	D	2.00 BSC			
Overall Width	Е	1.60 BSC			
Terminal Width	b1	0.30	0.35	0.40	
Terminal Width	b2	0.40	0.45	0.50	
Terminal Length	L	0.50	0.55	0.60	
Terminal 1 Index Chamfer	CH	-	0.15	-	

#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

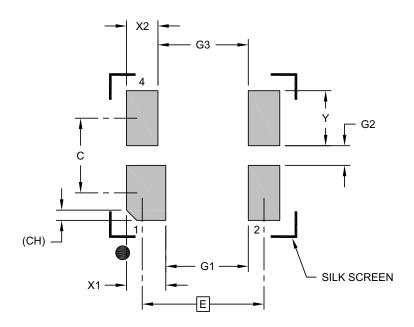
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-C04-1200 Rev B Sheet 2 of 2

## 4-Lead Very Thin Fine Pitch Land Grid Array (ASA) - 2.0x1.6 mm Body [VFLGA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



### RECOMMENDED LAND PATTERN

	MILLIMETERS				
Dimension	MIN	NOM	MAX		
Contact Pitch	Е		1.55 BSC		
Contact Spacing	С	0.95			
Contact Width (X4)	X1			0.50	
Contact Width (X2)	X2			0.40	
Contact Pad Length (X6)	Υ	0.7		0.70	
Space Between Contacts	G1	1.05			
Space Between Contacts (X2)	G2	0.25			
Space Between Contacts	G3	1.15			
Contact 1 Index Chamfer	CH	0	.13 X 45° RE	F	

#### Notes:

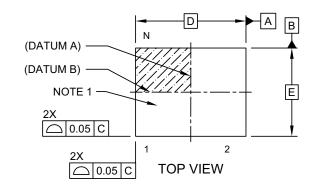
Dimensioning and tolerancing per ASME Y14.5M
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.

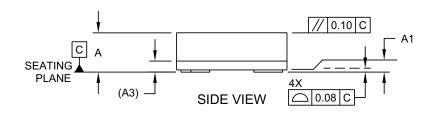
Microchip Technology Drawing C04-3200 Rev B

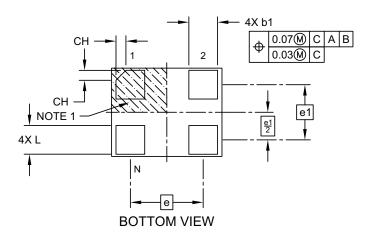
# 4-Lead Very Thin Land Grid Array (AUA) 2.5 mm x 2.0 mm Package Outline and Recommended Land Pattern (VLGA)

### 4-Lead Very Thin Land Grid Array (AUA) - 2.5x2.0 mm Body [VLGA]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



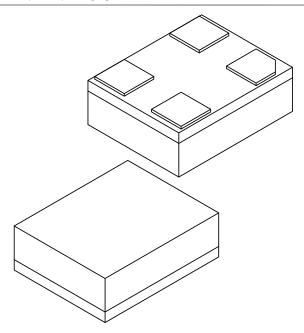




Microchip Technology Drawing C04-1202A Sheet 1 of 2

## 4-Lead Very Thin Land Grid Array (AUA) - 2.5x2.0 mm Body [VLGA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	N	IILLIMETER	S		
Dimension	MIN	NOM	MAX		
Number of Terminals	Ν	4			
Terminal Pitch	е		1.65 BSC		
Terminal Pitch	e1	1.25 BSC			
Overall Height	Α	0.79 0.84 0.89			
Standoff		0.00	0.02	0.05	
Substrate Thickness (with Terminals)	A3	0.20 REF			
Overall Length	D	2.50 BSC			
Overall Width	Е	2.00 BSC			
Terminal Width	b1	0.60	0.65	0.70	
Terminal Length	Ĺ	0.60	0.65	0.70	
Terminal 1 Index Chamfer	CH	-	0.225	-	

#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

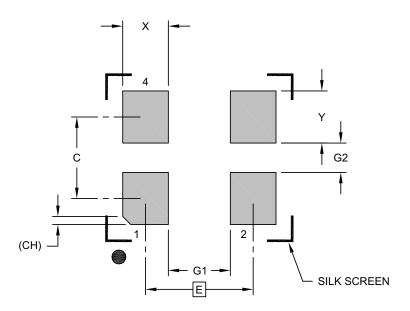
 ${\tt BSC: Basic \ Dimension. \ Theoretically \ exact \ value \ shown \ without \ tolerances.}$ 

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1202A Sheet 2 of 2

### 4-Lead Very Thin Land Grid Array (AUA) - 2.5x2.0 mm Body [VLGA]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



**RECOMMENDED LAND PATTERN** 

	MILLIMETERS						
Dimension	MIN	NOM	MAX				
Contact Pitch	Contact Pitch E		1.65 BSC				
Contact Spacing	С	1.25					
Contact Width (X4) X				0.70			
Contact Pad Length (X6) Y				0.80			
Space Between Contacts (X4)	G1	0.95					
Space Between Contacts (X3) G2		0.45		·			
Contact 1 Index Chamfer	(	).13 X 45° RE	:F				

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

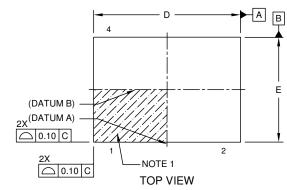
Microchip Technology Drawing C04-3202A

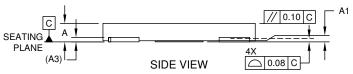
# 4-Lead Very Thin Dual Flatpack, No Lead Package (JZA) 7 mm x 5 mm x 0.9 mm (VDFN) Package Outline and Recommended Land Pattern with 2.2 mm x 3.5 mm Exposed Pad

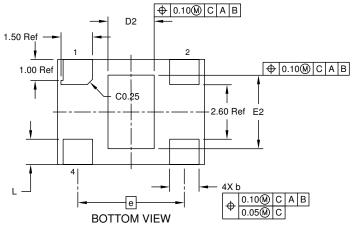


## 4-Lead Very Thin Dual Flatpack, No Lead Package (JZA) - 7x5x0.9 mm Body [VDFN] With 2.2x3.5 mm Exposed Pad

bte: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging







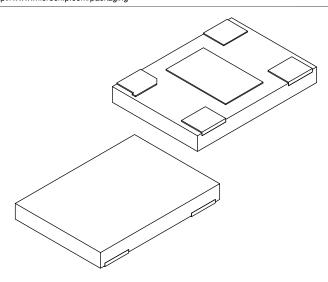
Microchip Technology Drawing C04-1025 Rev A Sheet 1 of 2

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## 4-Lead Very Thin Dual Flatpack, No Lead Package (JZA) - 7x5x0.9 mm Body [VDFN] With 2.2x3.5 mm Exposed Pad

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension	Dimension Limits		NOM	MAX	
Number of Terminals	Ν	004			
Pitch	е	5.08 Ref			
Overall Height	Α	0.80	0.85	0.90	
Standoff	A1	0.00	-	0.05	
Terminal Thickness	A3	0.203 Ref			
Overall Length	D	6.90	7.00	7.10	
Exposed Pad Length	D2	2.10	2.20	2.30	
Overall Width	Е	4.90	5.00	5.10	
Exposed Pad Width	E2	3.40	3.50	3.60	
Terminal Width	b	1.35	1.40	1.45	
Terminal Length	L	1.10	1.20	1.30	

1. Pin 1 visual index feature may vary, but must be located within the pin 1 area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

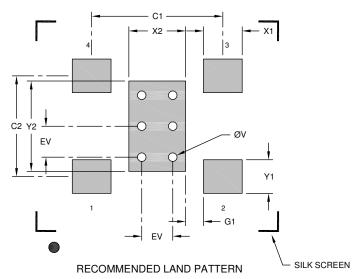
Microchip Technology Drawing C04-1025 Rev A Sheet 2 of 2

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## 4-Lead Very Thin Dual Flatpack, No Lead Package [JZA] - 7x5x0.9 mm Body [VDFN] With 2.2x3.5 mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Optional Center Pad Width	X2			2.30
Optional Center Pad Length	Y2			3.60
Contact Pad Spacing	C1		5.08	
Contact Pad Spacing	C2		3.90	
Contact Pad Width (Xnn)	X1			1.50
Contact Pad Length (Xnn)	Y1			1.30
Contact Pad to Center Pad (Xnn)	G1	0.69		
Thermal Via Diameter	V		0.33	
Thermal Via Pitch	EV		1.20	

#### Notes:

- Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- 2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-3025 Rev A

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NOTES:

## **APPENDIX A: REVISION HISTORY**

## Revision A (June 2021)

• Initial release of DSC150x/DSC152x as Microchip data sheet DS20006516A.

NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

DSC15:  0 = 2 =   1 = 2 = 3 =	Drive Strength  Low-Power Low-Jitter ( Oscillator  Standby Function (STB) Enable/Disable Function  LVCMOS Medium Drive LVCMOS Standard Drive				521ML3A-		Type
0 = 2 = 1 = 2 = 3 = 1	Oscillator  Standby Function (STB) Enable/Disable Function  LVCMOS Medium Drive			a) DSC1	521ML3A-		ledium Drive, 4-
2 = 1 = 2 = 3 =	Enable/Disable Function  LVCMOS Medium Drive						edium Drive, 4-
2 = 3 =				a) DSC1521ML3A- 50M00000: Pin1 OE, CMOS Medium Drive, Lead 2.0 mm x 1.6 mm, -40°C to 105°C Temperature Range, ±20 ppm, 50 MHz, Bulk.			
	LVCMOS Low Drive (2.5 LVCMOS Low Drive (1.8	(2.5V.3.3V) V.3.3V) V)		b) DSC1502JI1A- 100M0000T: Pin1 STB, CMOS Standard Lead 2.5 mm x 2.0 mm, -4 85°C Temperature Range, 100 MHz, 1,000 Reel.			mm, -40°C to Range, ±50 ppm,
-	2.5 mm x 2.0 mm 4-Lead	d VDFN d VLGA		Note 1:	catalog p used for the device Sales Of	e package. Check wit fice for package availa	n. This identifier is d is not printed on th your Microchip
E = I = L = A =	-40°C to +85°C (Industr -40°C to +105°C (Exten	ial) ded Industrial)					
1 = 2 = 3 =	±50 ppm ±25 ppm ±20 ppm						
A =	Revision A						
xxMxxxxx=	10.00000 MHz to 99.999	999 MHz					
  T = B =			age				
JN EIL # 123 # XXXX < 1E	J = M =	J = 2.5 mm x 2.0 mm 4-Lead M = 2.0 mm x 1.6 mm 4-Lead E = -20°C to +70°C (Extend	U = 2.5 mm x 2.0 mm 4-Lead VLGA U = 2.0 mm x 1.6 mm 4-Lead VLGA E = -20°C to +70°C (Extended Commercial) = -40°C to +85°C (Industrial) = -40°C to +105°C (Extended Industrial) A = -40°C to +125°C (Automotive)  U = ±50 ppm E = ±25 ppm E = ±25 ppm E = ±20 ppm E = ±20 ppm E = Bulk (100/Bag) for 2.0 mm x 1.6 mm Packa Bulk in Tube for Other Packages U = 1,000/Reel E = 1,000/Reel	U = 2.5 mm x 2.0 mm 4-Lead VLGA  U = 2.0 mm x 1.6 mm 4-Lead VLGA  E = -20°C to +70°C (Extended Commercial)	U = 2.5 mm x 2.0 mm 4-Lead VLGA  U = 2.0 mm x 1.6 mm 4-Lead VLGA  E = -20°C to +70°C (Extended Commercial)	A = 7.0 mm x 5.0 mm 4-Lead VDFN  J = 2.5 mm x 2.0 mm 4-Lead VLGA  Sales Off  Tape and  E = -20°C to +70°C (Extended Commercial)  = -40°C to +85°C (Industrial)  = -40°C to +105°C (Extended Industrial)  A = -40°C to +125°C (Automotive)  I = ±50 ppm  E = ±25 ppm E = ±25 ppm E = ±20 ppm  A = Revision A   A = Revision A  A = Revision A  A = Revision A  A = Revision A  A = Revision A  A = Revision A  A = Revision A  A = Revision A  Bulk (100/Bag) for 2.0 mm x 1.6 mm Package  Bulk in Tube for Other Packages  E = 1,000/Reel	A = 7.0 mm x 5.0 mm 4-Lead VDFN  J = 2.5 mm x 2.0 mm 4-Lead VLGA  M = 2.0 mm x 1.6 mm 4-Lead VLGA  E = -20°C to +70°C (Extended Commercial)  = -40°C to +85°C (Industrial)  = -40°C to +105°C (Extended Industrial)  A = -40°C to +125°C (Automotive)  I = ±50 ppm  E = ±25 ppm  B = ±20 ppm  A = Revision A   A = Revision A  A = Revision A  A = Revision A  A = Revision A  A = Revision A  A = Revision A  Bulk (100/Bag) for 2.0 mm x 1.6 mm Package  Bulk in Tube for Other Packages  F = 1,000/Reel

Please visit the Microchip ClockWorks Configurator® website to configure the part number for customized frequency select settings.

http://clockworks.microchip.com/timing

NOTES:

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